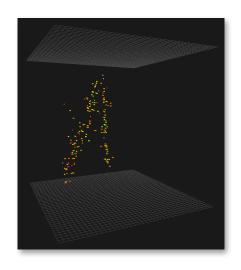
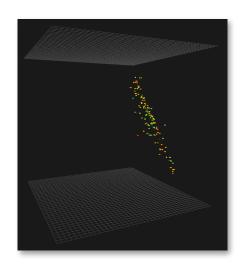




ARIADNE+: Large scale demonstration of TimePix3 optical readout with novel glass THGEMs in a LArTPC at the CERN Neutrino Platform

HEP Annual Meeting - Adam Lowe, PhD Second Year





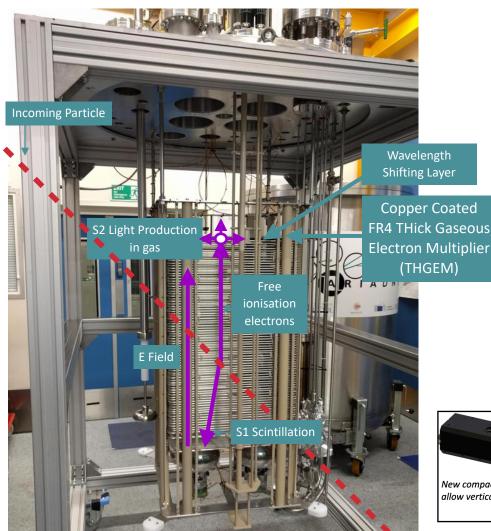


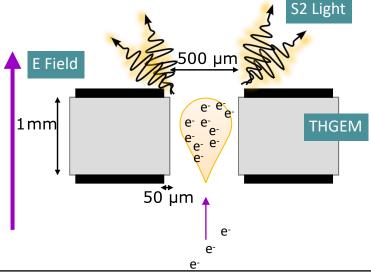


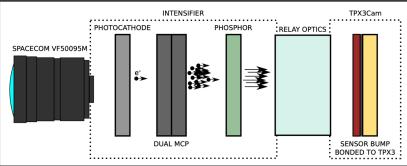




ARIADNE (**AR**gon **ImA**ging **D**etectio**N** chamb**E**r)









ARIADNE Detector - 1 Tonne LAr TPC located within the Oliver Lodge Building



The ARIADNE+ Detector

- ProtoDUNE Charge Readout Plane (CRP) test cryostat, also known as the Cold Box, is a 15 tonne TPC located at the CERN Neutrino Platform at Prévessin, France next to ProtoDUNE Dual Phase
- Mounted underneath is the 2.5 x 2.5 m ARIADNE+ Light Readout Plane (LRP) imaging cosmic muons with 4 TimePix Cameras; 3 imaging visible and 1 Vacuum Ultraviolet (VUV) light







ProtoDUNE as seen from the cold box







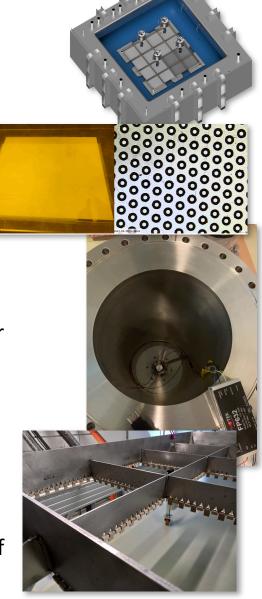
The ARIADNE+ Detector - Innovative Ideas

 Glass THGEMs - Less prone to sagging compared to FR4 at larger surface areas, conical hole shape collects charge over time and increases light output

 Polyethylene Naphthalate (PEN) Film coated glass panels for Wavelength Shifting (WLS) - commercially available in different easier to apply to surfaces then alternatives (TPB)

 VUV intensifier - imaging the THGEM directly without the need for any WLS

- Invar support structure Uniquely low coefficient of thermal contraction, ideal for keeping glass THGEMs and glass WLS panels in one piece!
- Chemically etched extraction grid 15 mm from THGEM instead of 10 mm on ProtoDUNE dual-phase







Second Year Work

- July October 2021
 - Refining the procedure and making the 12 pieces of WLS glass
 - Assembling the top of our re-entrant viewport hats that TPX3 assemblies will mount to
- November 2021 January 2022
 - Move to CERN!
 - Making a cleanroom from scratch in preparation for the arrival of shipments from USA, Liverpool and DSM







Second Year Work

- February March 2022
 - Received the materials to begin construction and preliminary THGEM testing in Mini-ARIADNE (MARIA)
 - Setting up the DAQ on the CERN network
 - Install the LRP (Light Readout Plane) within the Cold Box
 - Begin data collection
- April Present 2022
 - Decommissioning the detector
 - Data analysis







Building the ARIADNE+ Cleanroom

ARIADNE+'s base at the CERN Neutrino Platform

From this...



To this...



Finished Product



Constructing the Light Readout Plane (LRP) and Re-entrant Hats

- Consisting of nearly 1000 PEEK pieces, 12 sheets of WLS glass,
 16 50 x 50 cm glass THGEMS and a stainless steel extraction grid
- Month and a half of assembly
- Nitrogen flushed re-entrant hats mounting for the TimePix3
 assembly with motorised on/off and focusing
 19/05/2022







THGEM Testing using MARIA

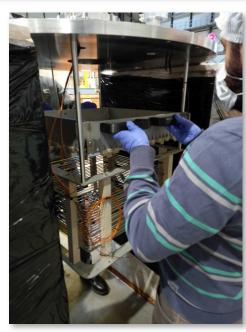
- Parallel with LRP assembly, select glass THGEMs were tested in Mini-ARIADNE (MARIA)
- Essential for understanding behaviour and "training" before mounting in LRP
- Secured in a mini-LRP, tests were done in gas with an alpha source and EMCCD

First time glass THGEMs of this size used in a TPC











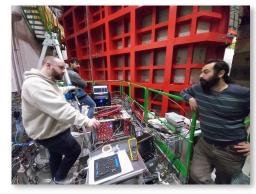




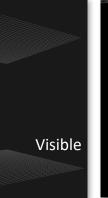


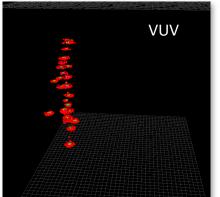
Data Taking

- Good Cold Box purity was assured for a week at a time, data taking split over two weeks - 5 of us taking data for 18 hours a day!
- Monitoring LAr level with temperature sensors, level meters and webcams
- Working in conjugation with the Galician Institute for High Energy Physics (IGFAE), part of the ARIADNE+ collaboration, assisting with taking S1 data with photodetectors embedded in the cathode (known as ARAPUCAS)
- Plan is to correlate S1 with S2 data in the future









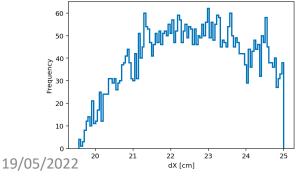


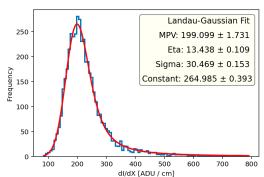


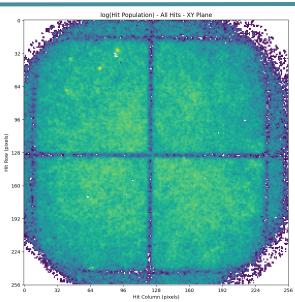


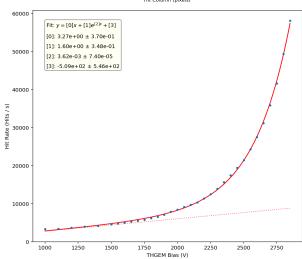
Preliminary Analysis

- Of 255 x 255 pixels TimePix3 chip, each pixel images approximately 4.6 mm of the 1 x 1 m active area
- 30 second camera exposure (visible light) hits heat map
- Glass THGEM gain graph has a clear linear and exponential region
- Initial calibration/resolution -
 - Energy conversion: 199.10 ± 1.73 ADU / MeV
 - Energy resolution: 16.73 ± 0.16 %









dX and dI/dX for 4483 events







The Team

Extra Slides







Optical sensor bump bonded to TimePix3 chip

Simultaneous 10 bit **Time over Threshold (ToT)** and 18 bit **Time of Arrival (ToA)** readout

ToT is used for calorimetry, ToA for timing

Only active pixels readout for instant background suppression

Superior timing resolution compared to EMCCD (1.6 ns)

Frame-based Readout Data-driven Readout **Events** (EMCCDs) (TPX3CAM) ToT ToA 100 102 107 110 111 114 116 117 120 122 126 127 129 132 134 137

Native 3-D readout